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Sommario/riassunto	This new volume introduces readers to the current topics of industrial and applied mathematics in China, with applications to material science, information science, mathematical finance and engineering. The authors utilize mathematics for the solution of problems. The purposes of the volume are to promote research in applied mathematics and computational science; further the application of mathematics to new methods and techniques useful in industry and science; and provide for the exchange of information between the

mathematical, industrial, and scientific communities.
